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Description

Available in PGA (PUMA 2) and Gullwing (PUMA77) • footprints. The PUMA **F16006 is a 16MBit Flash • module user configurable as 512K x 32, 1M x 16 or 2M x 8. The device is available with access times of 70, 90 and 120ns. The device utilises, 5V only Flash, to simplify circuit design. Sector size is 64K Byte with hardware protection available on any number of sectors. The device features 10,000 Write erase cycle compatibility and 10 year data retention. All options may be screened in accordance with MIL-STD-883.

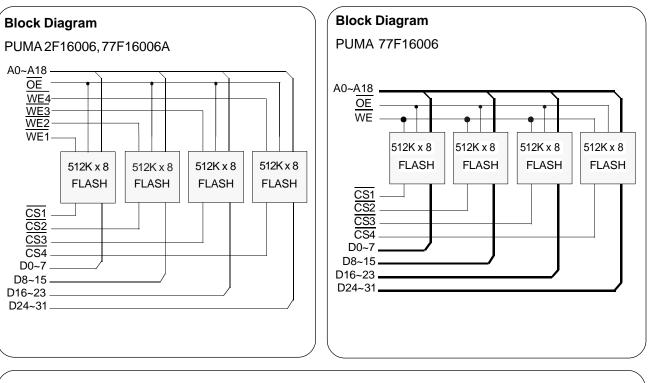
512K x 32 FLASH MODULE

PUMA 2/77F16006/A - 70/90/12

Issue 4.2 : November 1998

Features

- 16 Megabit FLASH module.
- Fast Access Times of 70/90/120 ns.
- Output Configurable as 32 / 16 / 8 bit wide.
- Operating Power 880/451/237 mW (Max).
 Low Power Standby 2.2mW (Max).
- Automatic Write/Erase by Embedded Algorithm end of Write/Erase indicated by DATA Polling and Toggle Bit.
- Flexible Sector Erase Architecture 64K byte sector size, with hardware protection of any number of sectors.
- Single Byte Program of 16µs (Min.), Sector Program time of 1 sec (typ.)
- Erase/Write Cycle Endurance 100,000 (Min.) Evariant.
- May be screened in accordance with MIL-STD-883.
- 10 year Data Retention.



Pin Functions

- D0~D31
 - WE1~4 Vcc
- Data Inputs/Outputs Write Enables Power (+5V)

A0~A18 CS1~4 OE GND Address Input Chip Selects Output Enable Ground

Absolute Maximum Ratings (1)

	max	unit
Voltage on any pin w.r.t. Gnd	-2.0 to +7.0	V
Supply Voltage ⁽²⁾	-2.0 to +7.0	V
Voltage on A9 w.r.t. Gnd (3)	-2.0 to +14	V
StorageTemperature	-65 to +150	°C

Notes : (1) Stresses above those listed may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not implied.

(2) Minimum DC voltage on any input or I/O pin is -0.5V. Maximum DC voltage on output and I/O pins is Vcc+0.5V During transitions voltage may overshoot by +/-2V for up to 20ns

(3) Minimum DC input voltage on A9 is -0.5V during voltage transitions, A9 may overshoot Vss to -2V for periods of up to 20ns, maximum DC input voltage in A9 is 13.5V which may overshoot to 14.0V for periods up to 20ns

Recommended Operating Conditions

Parameter	min	typ	max	unit		
Supply Voltage	V _{cc}	4.5	5.0	5.5	V	
Input High Voltage	V _{IH}	2.0	-	V _{cc} +0.5	V	
Input Low Voltage	V,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	$0.7V_{cc}$	-	V _{cc} +0.3	V	
Operating Temperature	T	0 ँ	-	⁰⁰ 70	°C	
	T _{AI}	-40	-	85	°C	(-I suffix)
		-55	-	125	°C	(-M\MB suffix)

DC Electrical Characteristic (T_A =-55°C to +125°C, V_{cc} =5V ± 10%)

typ	max	Unit
-	±4	μA
-	200	μA
-	±1	μA
-	±4	μA
-	160	mA
-	82	mA
-	43	mA
-	240	mA
-	122	mA
-	63	mA
-	4	mA
-	12.5	V
-	10.5	V
-	0.45	V
-	-	V
-	4.2	V
		$ \begin{array}{rrrrrrrrrrrrrrrrrrrrrrrrrrrrrrrrrrrr$

Notes (1) \overline{CS} above are accessed through $\overline{CS1}$ -4. These inputs must be operated simultaneoulsy for 32 bit operation,

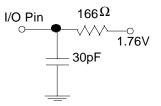
Capacitance (T_A=25°C,f=1MHz)

Parameter		Symbol	Test Condition	typ	max	Unit
Input Capacitance	Address, OE	C _{IN1}	V _{IN} =0V	-	30	pF
	Other pins	C _{IN2}	V _{IN} =0V	-	36	pF
Output Capacitance	32 bit	C _{OUT32}	V _{out} =0V	-	48	pF

Note: These parameters are calculated, not measured.

AC Test Conditions

- * Input pulse levels : 0.0V to 3.0V
- * Input rise and fall times : 5 ns
- * Input and output timing reference levels : 1.5V
- * VCC = 5V +/- 10%
- * Module tested in 32 bit mode



AC OPERATING CONDITIONS Read Cycle

ParameterSymbol			70			90			120		
-		min	typ	max	min	typ	max	min	typ	max	Unit
Read Cycle Time	tRC	70	-	-	90	-	-	120	-	-	ns
Address to output delay	tACC	-	-	70	-	-	90	-	-	120	ns
Chip enable to output	tCE	-	-	70	-	-	90	-	-	120	ns
Output enable to output	tOE	-	-	35	-	-	35	-	-	50	ns
Output enable to output High Z	tDF	-	-	20	-	-	20	-	-	30	ns
Output hold time from address	tOH	0	-	-	0	-	-	0	-	-	ns
CS or OE whichever occurs first											

PUMA 2/77 F16006/A - 70/90/12

Write/Erase/Program

Param	neter	Symbol				
		,	min	typ	max	unit
Write	Cycle time (4)	t _{wc}	90	-	-	ns
Addre	ss Setup time	t _{AS}	0	-	-	ns
Addres	ss Hold time	t _{AH}	50	-	-	ns
Data S	Setup Time	t _{DS}	50	-	-	ns
Data h	old Time	t _{DH}	0	-	-	ns
Output	t Enable Setup Time	t _{oes}	0	-	-	ns
Read F	Recover before Write	t _{GHWL}	0	-	-	ns
CS se	tup time	t _{ce}	0	-	-	ns
CS ho	ld time	t _{сн}	0	-	-	ns
WE P	ulse Width	t _{wP}	50	-	-	ns
WE P	ulse Width High	t _{wph}	20	-	-	ns
Progra	mming operation	t _{whwh1}	-	16	-	μs
Sector	Erase operation (1)	t _{whwh2}	-	1	30	sec
Chip E	rase operation (1)	t _{whwh2}	-	8	-	sec
Vcc se	etup time (4)	t _{vcs}	50	-	-	μs
Voltag	e Transition Time (2,4)		4	-	-	μs
Write	Pulse Width 1 ⁽²⁾	t _{wpp1}	100	-	-	μs
Write	Pulse Width 2 (2)	t _{wpp2}	10	-	-	ms
OE se	tup to $\overline{\text{WE}}$ active ^(2,4)	t _{OESP}	4	-	-	μs
CS se	tup to \overline{WE} active ^(3,4)	t _{CSP}	4	-	-	μs

Notes: (1) This does not include the preprogramming time.

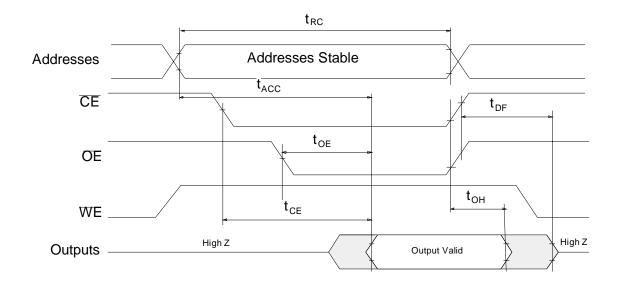
(2) These timings are for Sector Protect/Unprotect operations.
(3) This timing is only for Sector Unprotect.
(4) Not 100% tested.

Write/Erase/Program Alternate CS controlled Writes

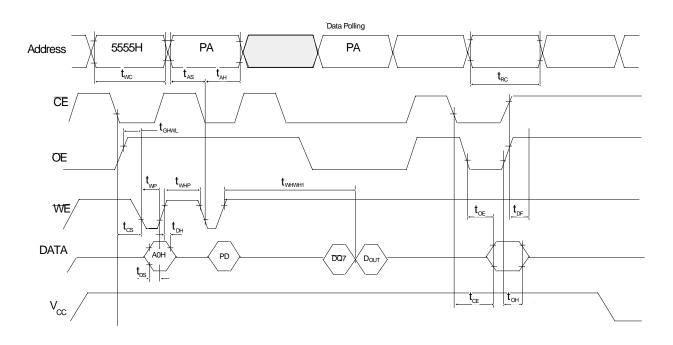
Parameter	Symbol				
		min	typ	max	Unit
Write Cycle time (2)	t _{wc}	90	-	-	ns
Address Setup time	t _{AS}	0	-	-	ns
Address Hold time	t _{AH}	50	-	-	ns
Data Setup Time	t _{DS}	50	-	-	ns
Data hold Time	t _{DH}	0	-	-	ns
Output Enable Setup Time	t _{oes}	0	-	-	ns
Read Recover before Write	t _{GHEL}	0	-	-	ns
WE setup time	t _{ws}	0	-	-	ns
WE hold time	t _{wH}	0	-	-	ns
CS Pulse Width	t _{CP}	50	-	-	ns
CS Pulse Width High	t _{CPH}	120	-	-	ns
Programming operation	t _{whwh1}	-	16	-	us
Sector Erase operation (1)	t _{whwh2}	-	1	30	sec
Chip Erase operation (1)	t _{whwh2}	-	8	-	sec
Vcc setup time (2)	t _{vcs}	-	50	-	us

Note: (1) Does not include pre-programming time. (2) Not 100% tested.

AC Waveforms for Read Operation



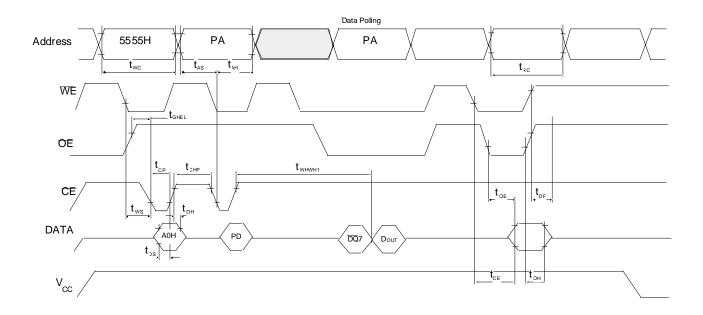
AC Waveforms Program



Notes:

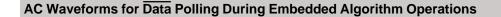
- 1. PA is address of the memory location to be programmed.
- 2. PD is data to be programmed at byte address.
- 3. DQ7 is the out put of the complement of the data written to the device.
- 4. DOUT is the output of the data written to the device.
- 5. Figure indicates last two bus cycles of four bus cycle sequence.

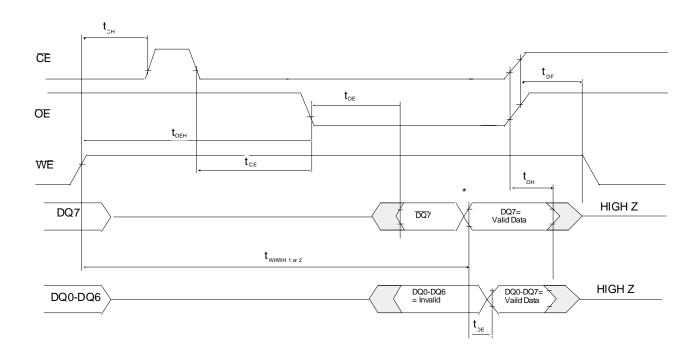
A.C Waveforms - Alternate CS controlled Program operation timings



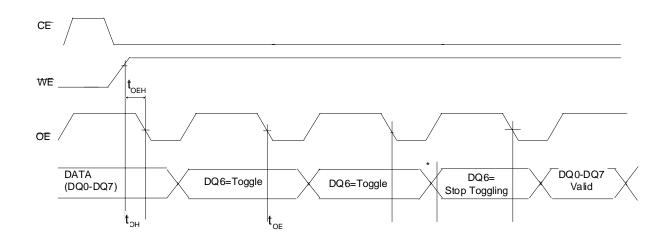
NOTES:

- 1. PA is address of memory location to be programmed.
- 2. PD is data to be programmed at byte address.
- 3. DQ7 is the output of the complement of the data written to the device.
- 4. DOUT is the output of the data written to the device.
- 5. Figure indicates last two bus cycles of four bus cycle sequence.

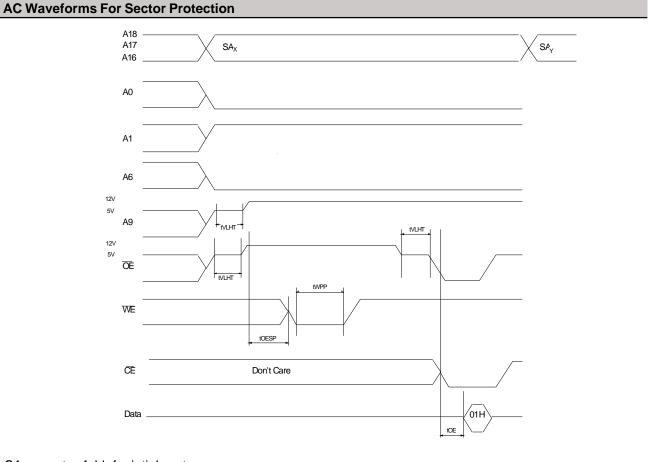




AC Waveforms for Toggle Bit During Embedded Algorithm Operations

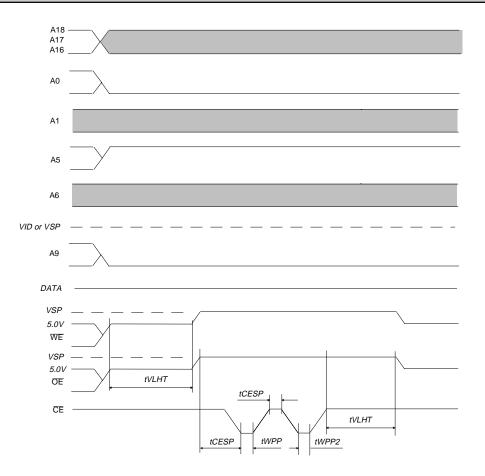


* DQ6 stops toggling (the device has completed the embedded operations)

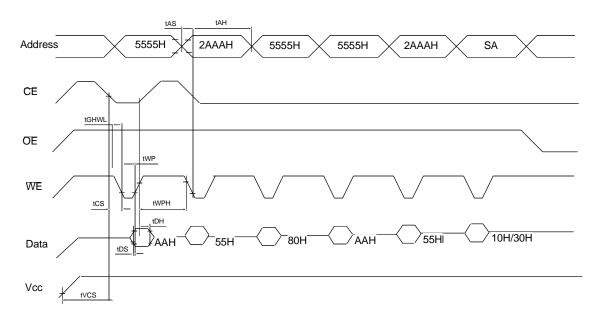


 SA_x = sector Addr for initial sector SA_y = sector Addr for next sector

AC Waveforms for Sector Unprotect



AC Waveforms Chip / Sector Erase

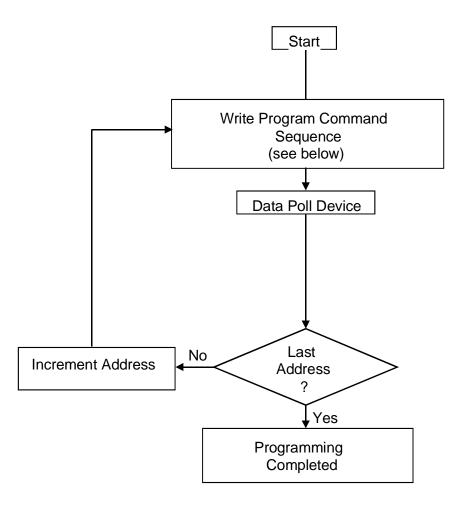


NOTES:

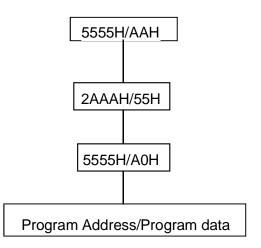
1. SA is the address for sector erase. Addresses = don't care for Chip Erase.

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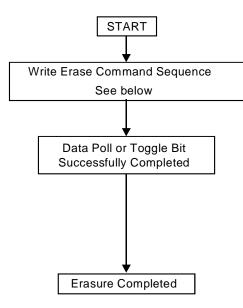
Embedded Programming Algorithm



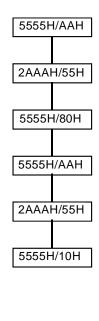
Program Command Sequence (Address /Command)



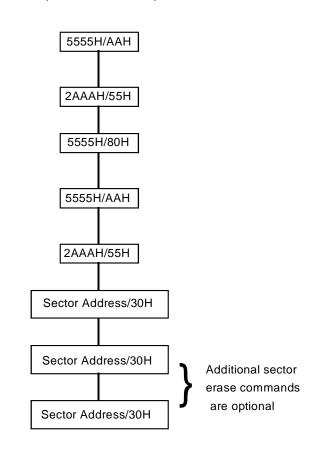
Embedded Erase Algorithm



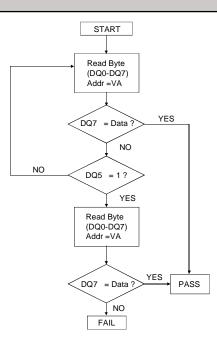
Chip Erase Command Sequence (Address/Command):



Individual Sector/Mulitiple Sector Erase Command Sequence (Address/Command):



Data Polling Algorithm

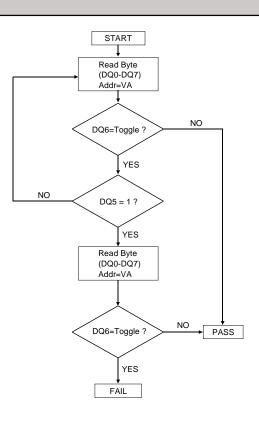


NOTE:

1. DQ7 is rechecked even if DQ5 = 1 because DQ7 may change simultaneously with DQ5.

- 2. VA = Byte address for programming.
 - = Any of the sector addresses within the sector being erased during sector erase operation
 - = XXXXXH during chip erase

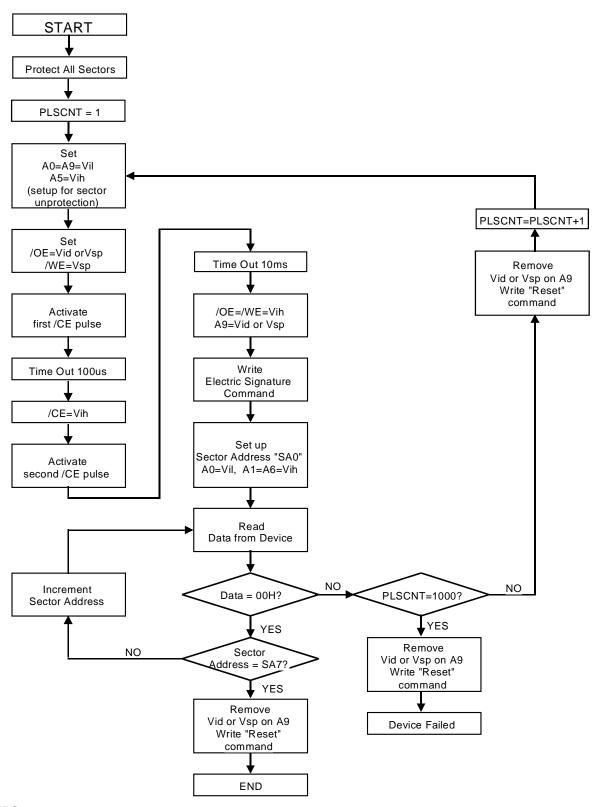
Toggle Bit Algorithm



NOTES:

1. DQ6 is rechecked even if DQ5 = 1 because DQ6 may stop toggling at the same time as DQ5 changing to "1". 2 VA = As above.

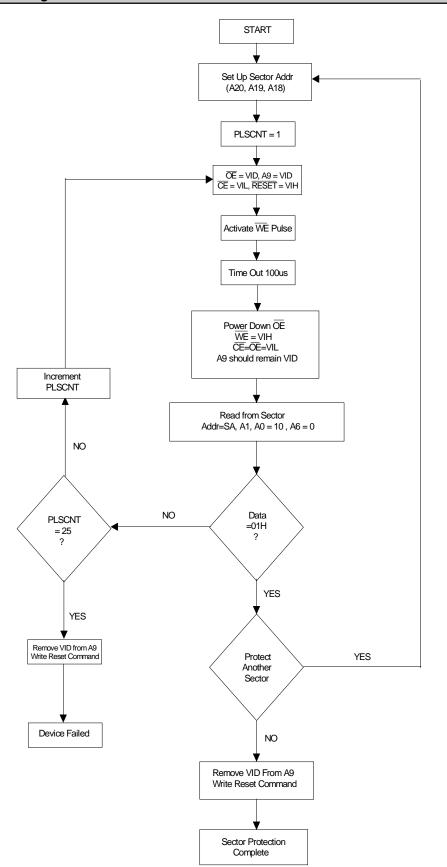
Sector Unprotect Algorithm



NOTES:

SA0 = The First Sector Address SA7 = The Last Sector Address (Sector Address is indicated using A16 to A18)

Sector Protection Algorithm



Device Operation

The following description deals with the device operating in 8 bit mode accessed through CS1, however status flag definitions shown apply equally to the corresponding flag for each device in the module.

Read Mode

The device has two control functions which must be satisfied in order to obtain data at the outputs $\overline{CS1}$ ~4 is the power control and should be used for device selection

OE is the output control and should be used to gate data to the output pins if the device is selected.

Standby Mode

Two standby modes are available :

CMOS standby : CS1~4 held at Vcc +/- 0.5V

TTL standby : CS1~4 held at V

In the standby mode the outputs are in a high impedance state independent of the \overline{OE} input. If the device is deselected during erasure or programming the device will draw active current until the operation is completed.

Output Disable

With the \overline{OE} input at a logic high level (V_{IH}), output from the device is disabled. This will cause the output pins to be in a high impedance state.

Autoselect

The autoselect mode allows the reading out of a binary code from the device and will identify the die manufacturer and type. This mode is intended for use by programming equipment. This mode is functional over the full military temperature range. The autoselect codes for the first device are as follows :

Туре	A18	A17	A16	A6	A1	A0	Code (HEX)	DQ7	DQ6	DQ5	DQ4	DQ3	DQ2	DQ1	DQ0
Manufacture Code	х	х	Х	V _{IL}	V _{IL}	V _{IL}	04H	0	0	0	0	0	0	0	1
Device Code	х	Х	х	V _{IL}	V _{IL}	V _{IH}	A4H	1	0	1	0	0	1	0	0
Sector Protection	Sector	Address	V _{IL}	V _{IH}	V _{IL}	01H*	0	0	0	0	0	0	0	1	

* Outputs 01H at protected sector address

To activate this mode the programming equipment must force V_{ID} on address A9. Two identifier bytes may then be sequenced from each die device outputs by toggling A0 from V_{IL} to V_{IH} . All addresses are dont care apart from A1 & A0. All identifiers for manufacturer and device will exhibit odd parity with D7 defined as the parity bit. In order to read the proper device codes when executing the autoselect A1 must be V_{IL} .

Write

Device erasure and programming are accomplished via the command register. The contents of the register serve as inputs to the internal state machine. The state machine outputs dictate the function of the device. The register is a latch used to store the commands along with the address and data information required to execute the command. The command register is written by bringing WE to V_{IL} while CS1~4 is at V_{IL} and OE is at V_{IL} .Addresses are latched on the falling edge of WE while data is latched on the rising edge.

Command Definitions

Device operations are selected by writing specific address and data sequences into the command register. The following table defines these register command sequences.

Command Sequence Read/Reset	Bus Write Cvcles Req'd	First Bus Write Cycle		Second Bus Write Cycle		Third Bus Write Cycle		Fourth Bus Read/Write Cycle		Fifth Bus Write Cycle		Sixth Bus Write Cycle	
		Addr	Addr Data Addr Data Addr Data Addr Data Addr Data								Addr	Data	
Read/Reset	1	хххн	XXXH FOH										
Read/Reset	4	5555H	AAH	2AAAH	55H	5555H	F0H	RA	RD				
Autoselect	4	5555H	5555H AAH 2AAAH 55H 5555H 90H										
Byte Program	4	5555H	AAH	2AAAH	55H	5555H	A0H	PA	Data				
Chip Erase	6	5555H	5555H AAH 2AAAH 55H 5555H 80H 55555H AAH 2AAAH 55H 5555H 1								10H		
Sector Erase	6	5555H	55555H AAH 2AAAH 55H 55555H 80H 55555H AAH 2AAAH 555H SA 3								30H		
Sector Erase Suspen	d	Erase ca	n be suspe	ended durin	g sector e	erase with Ad	ddr (don't ca	are) Data (B	60H)				
Sector Erase Resume	9	Sector Erase Resume Erase can be resumed after suspend with Addr (Don't Care), Data (30H)											

Notes:

- 1. Address bit A₁₅, A₁₆, A₁₇, A₁₈=X=Don't care. Write Sequences may be initiated with A₁₅, A₁₇ and A₁₈ in either state.
- 2. Address bit A₁₅,A₁₆,A₁₇, A₁₈=X=Don't care for all address commands except for Program Address (PA) and Sector Address (SA).
- RA=Address of the memory location to be read.
 PA=Address of memory location to be programmed. Addresses are latched on the falling edge of the WE pulse.

SA=Address of the sector to be erased. The combination of A_{18} , A_{17} and A_{16} will uniquely select any sector.

4. RD=Data read from location RA during read operation. PD=Data to be programmed at location PA. Data is latched on the falling edge of WE

Read / Reset Command

The Read or Reset operation is initiated by writing the read/reset command sequence into the command register. Microprocessor read cycles retrieve array data from the memory. The device remains enabled for reads until the command register contents are altered.

The device will automatically power-up in the Read/Reset state. In this case, a command sequence is not required to read data. Standard microprocessor read cycles will retrieve array data. This default value ensures that no spurious alteration of memory content occurs during the power transition. Refer to the AC Read Characteristics and Waveforms for specific timing parameters.

Sector Protection

The device features hardware sector protection. This feature will disable both program and erase operations in any number of sectors (0 through 8). The sector protect feature is enabled using programming equipment at the users site. The device is shipped with all sectors unprotected.

To activate this mode, the programming equipment must force V_{ID} on address pin A₉ and control pin OE, and $\overline{CS}=V_{IH}$. The sector adresses (A₁₈, A₁₇ and A₁₆) should be set to the sector to be protected. Programming of the protection circuitry begins on the falling edge of the WE pulse and is terminated with the rising edge of the same. Sector addresses must be held constant during the WE pulse.

To verify programming of the protection equipment circuitry, the programming equipment must force V_{ID} on address pin A_g with CS and OE at V_{IL} and WE at V_{IH}. Reading the device at a particular sector address (A₁₆, A₁₇ and A₁₈) while (A₆, A₁, A₀) = (0,1,0) will produce 01H at data output D0 for a protected sector. Otherwise the device will read 00H for unprotected sector. In this mode, the lower order addresses, except for A₀, A₁ and A₆, are don't care. Address with A₁=V_{IL} are reserved for autoselect codes. If a verify of the sector protection circuitry were done at these addresses, the device would output the manufacturer and device codes respectively.

It is also possible to determine if a sector is protected in the system by writing the autoselect command. Performing a read operation at XX02H, where the higher order addresses (A16, A17, A18) are sector addresses,(other addresses are a don't care) will produce 01H data if those sectors are protected. Otherwise the devidce will read 00H for an unprotected sector.

SA0 0 0 0 000000h-0FFFh SA1 0 0 1 10000h-1FFFh SA2 0 1 0 20000h-2FFFh SA3 0 1 1 30000h-3FFFFh SA4 1 0 0 40000h-4FFFFh SA5 1 0 1 50000h-5FFFFh SA6 1 1 0 60000h-6FFFFh SA7 1 1 1 70000h-7FFFFh		A18	A17	A16	Address Range
SA2 0 1 0 20000h-2FFFFh SA3 0 1 1 30000h-3FFFFh SA4 1 0 0 40000h-4FFFFh SA5 1 0 1 50000h-5FFFFh SA6 1 1 0 60000h-6FFFFh	SA0	0	0	0	000000h-0FFFFh
SA3 0 1 1 30000h-3FFFFh SA4 1 0 0 40000h-4FFFFh SA5 1 0 1 50000h-5FFFFh SA6 1 1 0 60000h-6FFFFh	SA1	0	0	1	10000h-1FFFFh
SA4 1 0 0 40000h-4FFFFh SA5 1 0 1 50000h-5FFFFh SA6 1 1 0 60000h-6FFFFh	SA2	0	1	0	20000h-2FFFFh
SA5 1 0 1 50000h-5FFFh SA6 1 1 0 60000h-6FFFFh	SA3	0	1	1	30000h-3FFFFh
SA6 1 1 0 60000h-6FFFFh	SA4	1	0	0	40000h-4FFFFh
	SA5	1	0	1	50000h-5FFFFh
SA7 1 1 1 70000h-7FFFFh	SA6	1	1	0	60000h-6FFFFh
	SA7	1	1	1	70000h-7FFFFh

Sector Address Table

Sector Unprotect

Sectors which have previously been protected from being programmed or erased may be unprotected using the Sector Unprotect Algorithm. All sectors must be placed in the protection mode using the protection algorithm before unprotection can proceed.

A special high voltage for unprotection V_{sp} is defined to be 10V+/-0.5V.

The unprotection mode is entered by setting \overline{OE} to V_{ID} or V_{SP} , \overline{WE} to V_{SP} , A5 to V_{IH} and A0=A9 to V_{IL} . Unprotect is invoked by applying to negative pulses on \overline{CS} for a period of t_{WPP2} .

Autoselect Command

Flash memories are intended for use in applications where the local CPU alters memory contents. As such, manufacture and device codes must be accessible while the device resides in the target systems. PROM programmers typically access the signature codes by raising A_9 to a high voltage. However, multiplexing high voltage onto the address lines is not generally a desired system design practice.

The device contains an autoselect operation to supplement traditional PROM programming methodology. The operation is initiated by writing the autoselect command sequence into the command register. Following the command write, a read cycle from address XX00H retrieves the manufacture code of 01H. A read cycle from address XX01H returns the device code A4H. A read cycle from address XX2H returns information as to which sectors are protected. All manufacturer and device codes will exhibit odd parity with the MSB (D₇) defined as the parity bit.

To terminate the operation, it is necessary to write the read/reset command sequence into the register.

Byte Programming

The device is programmed on a byte-by-byte basis. Programming is a four bus cycle operation. There are two "unlock" write cycle. These are followed by the program set-up command and data write cycles. Addresses are latched on the falling edge of WE or CS1~4, whichever happens later, while the data are latched on the rising edge of WE or CS1~4 whichever happens first. The rising edge of WE or CS1~4 begins programming. Upon executing the Embedded Program Algorithm Command sequence, the system is not required to provide further control or timings. The device will automatically provide adequate internally generated program pulses and verify the programmed cell margin. The automatic programming operation is completed when data on D7 is equivalent to data written to this bit, (see written Operations Status) at which time the device returns to read mode. Data Polling must be performed at the memory location which is being programmed.

Programming is allowed in any address sequence and across sector boundaries.

Chip Erase

Chip erase is a six bus cycle operation. There are two "unlock" write cycles. These are followed by writing the "set-up" command. Two more "unlock" write cycles are then followed by the chip erase command. Chip erase doesn't require the user to program the device prior to erase. Upon executing the Embedded Erase Algorithm command sequence the device automatically will program and verify the entire memory for an all zero data pattern prior to electrical erase. The systems is not required to provide any controls or timings during these operations.

The automatic erase begins on the rising edge of the last \overline{WE} pulse in the command sequence and terminates when the data on D₇ is "1" (See Written Operation Section) at which time the device returns to read the mode.

Sector Erase

Sector erase is a six bus cycle operation. There are two "unlock" write cycles. These are followed by writing the "Set-up" command. Two more "unlock" write cycles are then followed by the sector erase command. The sector address (any address location within the desired sector) is latched on the falling edge of \overline{WE} , while the command (data) is latched on the rising edge of \overline{WE} . A time-out of 50us from the rising edge of the last sector erase command will initiate the sector erase command(s).

Multiple sectors may be erased concurrently by writing the six bus cycle operations as desribed above. This sequence is followed with writes of the sector erase command 30H to addresses in other sectors required to be concurrently erased. A time-out of 50us from the rising edge of the WE pulse for the last sector erase command will initiate the sector erase. If another sector erase command is written within the 50us time-out window the timer is reset. Any command other than sector erase within the time-out window will reset the device to the read mode, ignoring the previous command string (refer to Write Operation Status section for Sector Erase Timer operation). Loading the sector erase buffer may be done in any sequence and with any number of sectors (0 to 7).

Sector erase doesn't require the user to program the device prior to erase. The device automatically programs all memory locations in the sector(s) to be erased prior to electrical erase. When erasing a sector or sectors the remaining unselected sectors are not affected. The system is not required to provide any controls or timings during these operations

The automatic sector erase begins after the 50us time-out from the rising edge of the \overline{WE} pulse for the last sector erase command pulse and terminates when the data on D_7 is "1" (see Written Operation Status Section) at which time the device returns to read mode. Data polling must be preformed at an address within any of the sectors being erased.

Erase Suspend

Erase suspend allows the user to interupt the chip and read data (not program) from a non busy sector while it is in the middle of a sector erase operation, which may take several seconds.

The command can only be used during sector erase operation and otherwise will be ignored. The erase suspend command B0h is also allowed during the Sector Erase Operation that will include the sector erase time out period after the sector erase commands B0h. Writing this command during the timeout will result in immediate termination of the time out period and any subsequent writes of Sector Erase Command will be taken as Erase Resume.

To suspend the erase operation and go into erase suspend mode (pseudo read mode) requires between 0.1 and 10µs, during which time the user can read from a sector that is not being erased. The toggle bit stops toggling when the device enters pseudo read mode and an address of a sector not being erased must be used to read the toggle bit.

After the user writes the erase suspend command and waits until the toggle bit stops toggling, data reads from the device may then be performed. After an Erase Resume command the internal counters, which are used to count the high voltage pulses required to program or erase, are reset. The Exceed Time limit flag D5 is set if the count exceeds a certain limit. (The resetting of the counters is necessary as the erase suspend command an potentially interupt the high voltage pulses.)

Operating Modes

The following modes are used to control the device.

OPERATION	cs	ŌE	WE	A0	A1	A6	A9	I /O
Auto-Select Manufacturer Code	L	L	н	L	L	L	V _{ID}	Code
Auto Select Device Code	L	L	н	н	L	L	V _{ID}	Code
Read ⁽¹⁾	L	L	н	AO	A1	A6	A9	D _{OUT}
Standby	н	х	x	х	х	Х	х	High Z
Output Disable	L	н	н	х	Х	Х	х	High Z
Write	L	н	L	A0	A1	A6	A9	Din
Enable Sector Protect	L	V _{ID}	L	х	Х	Х	V _{ID}	Х
Verify Sector Protect	L	L	Н	L	Н	L	V _{ID}	Code

1) L=V_{IL}, H=V_{IH} X=Don't Care

NOTE: 1) $\overline{\text{WE}}$ can be V_{μ} if $\overline{\text{OE}}$ is V_{μ} , $\overline{\text{OE}}$ at V_{μ} initiates write cycle.

Write Operation Status

Hardware Sequence Flags

	STATUS	D7	D6	D5	D3	D2~D0
	Auto Programming	DQ7	Toggle	0	0	
In Progress	Programming in Auto-Erase	0	Toggle	0	1	(<u>D</u>)
	Erasing in Auto Erase	0	Toggle	0	1	
	Auto-Programming	DQ7	Toggle	1	1	
Exceeded	Programming in Auto Erase	0	Toggle	1	1	(D)
Time Limits	Erasing in Auto-Erase	0	Toggle	1	1	

Note: DQ0, DQ1, DQ2, DQ4 are reserve pins for future use.

D7 Data Polling

The device features Data Polling as a method to indicate to the host system that the Embedded Algorithms are in progress or completed.

During the Embedded Programming Algorithm, an attempt to read the device will produce complement data of the data last written to D₇. Upon completion of the Embedded Programming Algorithm an attempt to read the device will produce the true data last written to D₇. Data Polling is valid after the rising edge of the forth WE pulse in the four write pulse sequence.

During the Embedded Erase Algorithm, D_7 will be "0" until the erase operation is completed. Upon completion data at D_7 is "1". For chip erase, the Data Polling is valid after the rising edge of the sixth WE pulse in the six write pulse sequence. For sector erase, Data Polling is valid after the last rising edge of the sector erase WE pulse.

The Data Polling feature is only active during the Embedded Programming Algorithm, Embedded Erase Algorithm, or sector erase time-out.

D₆ Toggle Bit

The device also features the "toggle bit" as a method to indicate to the host system that the Embedded Algorithms are in progress or completed.

During an Embedded Program or Erase Algorithm cycle, successive attempts to read data from the device will result in D_6 toggling between one and zero. Once the Embedded Program or Erase Algorithm cycle is completed, D_6 will stop toggling and valid data will be read on successive attempts. During programming, the Toggle bit is valid after the rising edge of the forth WE pulse in the four write pulse sequence. For chip erase, the Toggle bit is valid after the last rising edge of the sector erase WE pulse. The Toggle Bit is active during the sector time-out.

D5 Exceeding Time Limits

 D_5 will indicate if the program or erase time has exceeded the specified limits. Under these conditions D_5 will produce "1", indicating the program or erase cycle was not successfully completed. Data Polling is the only operating function of the device under this condition. The \overline{CS} circuit will partially power down the device under these conditions (to approximately 2mA). The \overline{OE} and \overline{WE} pins will control the output disable functions. To reset the device, write reset command sequence to the device. This allows the system to continue to use the other active sectors in the device, if this failure occurs during sector erase operations, it specifies that a particular sector is bad and may not be re-used. The device must be reset to use other sectors. While the reset command sequence and execute program or erase command sequence.

If this failure occurs during chip erase operation, it specifies that the device chip or combination of sectors are bad. If this failure occurs during the byte programming operation, it specifies that the active sectors containing that byte is bad and may not be re-used.

The D5 failure condition may also appear if the user tries to program a non blank location without erasing. In this case the device locks out and never completes the embedded algorithm operation. Hence the system never reads a valid data on D7 and D6 never stops toggling. Once the device has exceeded timing limits, the D5 bit will indicate '1'

D4 Hardware Sequence Flag

If the device has exceeded the specified erase or program time and D_5 is "1", then D_4 will indicate at which step in the algorithm the device exceeded the limits. A "0" in D_4 indicates in programming, a "1" indicates an erase.

D3 Sector Erase Timer

After the completion of the initial sector erase command sequence the sector erase time-out will begin. D₃ will remain low until the time-out is complete. Data Polling and Toggle Bit are valid after the initial sector erase command sequence.

If Data Polling or the Toggle Bit indicates the device has been written with a valid erase command, D_3 may be used to determine if the sector erase timer window is still open. If D_3 is high the internally controlled erase cycle has begun; attempts to write subsequent commands to the device will be ignored until the erase operation is completed as indicated by Data Polling or Toggle Bit. If D_3 is low, the device will accept additional sector erase commands. To insure the command has been accepted, the software should check the status of D_3 prior to and following each subsequent sector erase command. If D_3 were high on the second status check, the command may not have been accepted.

Data Protection

The device is designed to offer protection against accidental erasure or programming caused by spurious system level signals that may exist during power transition. During power up the device automatically resets the internal state machine in the Read mode. Also, with its controls register architecture, alteration of the memory contents only occurs after successful completion of specific multi-bus cycle command sequences. The device also incorporates several features to prevent inadvertent write cycles resulting from Vcc power up and power down transitions or system noise.

Low Vcc Write Inhibit

To avoid initiation of a write cycle during V_{CC} power up and power down, a write cycle is locked out for V_{CC} less than 3.2V (typically 3.7V). If V_{CC}<V_{LKO}, the command register is disabled and all internal program/erase circuits are disabled. Under this condition the device will reset to read mode. Subsequent writes will be ignored until the V_{CC} level is greater than V_{LKO}. It is usually correct to prevent unintentional writes when V_{CC} is above 3.2V.

Write Pulse "Glitch" Protection

Noise pulses of less than 5ns (typical) on \overline{OE} , \overline{CS} , \overline{WE} will not initiate a write cycle

Logical Inhibit

Writing is inhibited by holding any one of $\overline{OE}=V_{\mathbb{L}}$, $\overline{CS}=V_{\mathbb{H}}$ or $\overline{WE}=V_{\mathbb{H}}$. To initiate a write cycle \overline{CS} and \overline{WE} must be logical zero while \overline{OE} is a logical one.

Power Up Write Inhibit

Power-up of the device with $\overline{WE} = \overline{CS} = V_{\parallel}$ and $\overline{OE} = V_{\parallel}$ will not accept commands on the rising edge of \overline{WE} . The internal state machine is automatically reset to the read mode on power-up.

Sector Protect

Sectors of the device may be hardware protected at the users factory. The protection circuitry will disable both program and erase functions for the protected sector(s). Requests to program or erase a protected sector will be ignored by the device.

Erase and Programming Performance

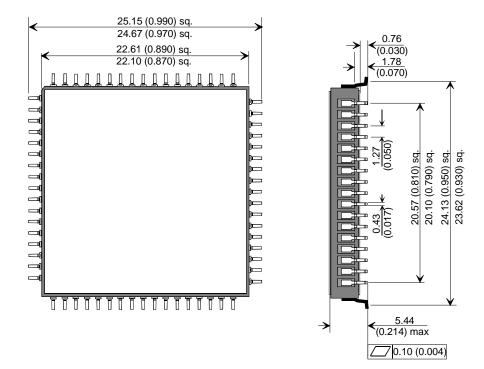
		Limits			
Parameter	Min	Тур	Max	Unit	Comments
Sector Erase Time		1 (Note 1)	30	sec	Excludes 00H programming prior to erasure.
Byte Programming Time		16	1000 (Note 2)	us	Excludes System-level overhead.
Chip Programming Time		8.0 (Note 1)	50	sec	Excludes system-level overhead.
Erase/Program Cycles	100,000	1,000,000		cycles	10,000 Min for none E variant

Notes: (1) 25°C, 5V V_{cc}, 100,000 cycles.

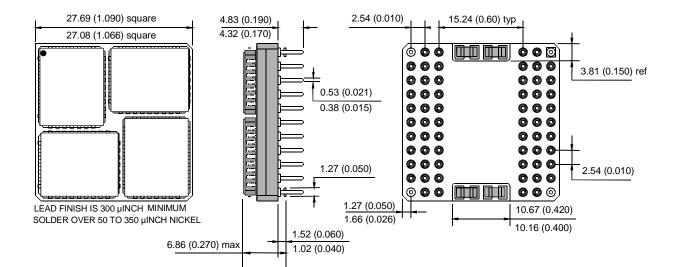
(2) The Embedded Algorithms allow for 48ms byte program time.

Package Details

PUMA77F16006

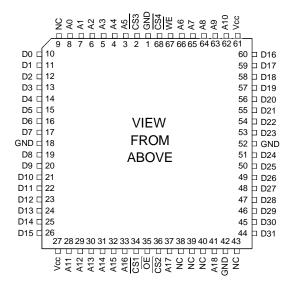


PUMA2F16006



Pin Definitions

PUMA 77F16006



PUMA 2F16006

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PUMA 77F16006A

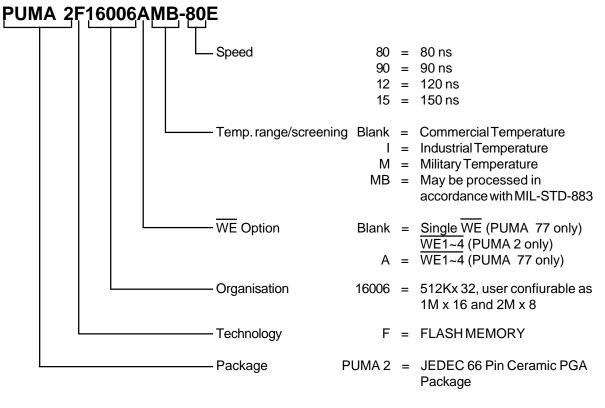
	S	AO	A1	Ŗ	A3	¥	A5	CS3	GND	CS4	ШŅ	A6	A7	A8	A9	A10	Vcc			
		8	7	6	5	4	3	2	1	68	67	66	65	64	63	62	61	٦		
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D2 🗆	12																58		D1	8
D3 🗆	1'																57		D1	9
D4 ⊏	1																56		D2	0
D5 🗆	1																55		D2	-
D6 🗆	1							٧I	E١	N							54		D2	
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GND □	-						-	-									52		GN	
D8 ⊏							Α	ΔB	O	VE							51	E	D2	
D9 🗆	1-0																50		D2	
D10 □ D11 □	21																49 48		D2	
	1																40		D2	
D12 L																	46		D2 D2	-
																	40		D2 D3	
D14 C																	43		D3	
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Military Screening Procedure

MultiChip Screening Flow for high reliability product in accordance with Mil-883 method 5004 shown below

MB MULTICHIP MODULE SCREENING FLOW								
SCREEN	TEST METHOD	LEVEL						
Visual and Mechanical								
Internal visual Temperature cycle Constant acceleration	2017 Condition B or manufacturers equivalent 1010 Condition B (10 Cycles,-55°C to +125°C) 2001 Condition E (Y ₁ only) (10,000g)	100% 100% 100%						
Burn-In								
Pre-Burn-in electrical Burn-in	Per applicable device specifications at T _A =+25°C Method 1015,Condition D,T _A =+125°C,160hrs min	100% 100%						
Final Electrical Tests	Per applicable Device Specification							
Static (dc)	 a) @ T_A=+25°C and power supply extremes b) @ temperature and power supply extremes 	100% 100%						
Functional	 a) @ T_A=+25°C and power supply extremes b) @ temperature and power supply extremes 	100% 100%						
Switching (ac)	 a) @ T_A=+25°C and power supply extremes b) @ temperature and power supply extremes 	100% 100%						
Percent Defective allowable (PDA)	Calculated at post burn-in at T _A =+25°C	10%						
Hermeticity	1014							
Fine	Condition A	100%						
Gross	Condition C	100%						
Quality Conformance	Per applicable Device Specification	Sample						
External Visual	2009 Per vendor or customer specification	100%						

Ordering Information



PUMA 77 = JEDEC 68 Leaded Gull Wing Ceramic Surface Mount package

NOTE : E is designated to parts with extended Erase/Write Cycle Endurance (100,000 Min.). If not specified when ordered only a Erase/Write Cycle Endurance of 10,000 Minimum can be guaranteed.

Note:

Although this data is believed to be accurate the information contained herein is not intended to and does not create any warranty of merchantibility or fitness for a particular purpose.

Our products are subject to a constant process of development. data may be changed at any time without notice. Products are not authorised for use as critical components in life support devices without the express written approval of a company director.